## What is claimed is:

10

25

1. An over-current protection device, comprising:

a positive temperature coefficient material layer;

an upper electrode foil disposed on the upper surface of the positive temperature coefficient material layer;

a lower electrode foil disposed on the lower surface of the positive temperature coefficient material layer;

a first metal terminal layer electrically connected to the upper electrode foil with at least one non-full-circular conductive through hole and at least one full-circular conductive through hole;

a second metal terminal layer electrically connected to the lower electrode foil with at least one non-full-circular conductive through hole and at least one full-circular conductive through hole; and

at least one insulating layer for isolating the upper electrode foil from the second metal terminal layer and the lower electrode foil from the first metal terminal layer.

- 2. The over-current protection device according to Claim 1, further comprising a solder mask disposed between the first metal terminal layer and the second metal terminal layer.
- 3. The over-current protection device according to Claim 1, wherein the full-circular conductive through hole is disposed on the surface of the first metal terminal layer and the second metal terminal layer.
  - 4. The over-current protection device according to Claim 2, wherein the full-circular conductive through hole is disposed on the surface of the solder mask and electrically connects first metal terminal layer and the second metal terminal layer by a metallic wire.

- 5. The over-current protection device according to Claim 1, wherein the non-full-circular conductive through hole is a half-circular conductive through hole or a quarter-circular conductive through hole.
  - 6. An over-current protection device, comprising:
- at least two over-current protection modules stacked vertically and electrically connected in parallel, each of the over-current protection modules including:
  - (a) a positive temperature coefficient material layer;
- (b) an upper electrode foil disposed on the upper surface of the positive temperature coefficient material layer; and
  - (c) a lower electrode foil disposed on the lower surface of the positive temperature coefficient material layer;
  - a first metal terminal layer electrically connected to the upper electrode foils of the at least two over-current protection modules with at least one non-full-circular conductive through hole and at least one full-circular conductive through hole;
  - a second metal terminal layer electrically connected to the lower electrode foils of the at least two over-current protection modules with at least one non-full-circular conductive through hole and at least one full-circular conductive through hole; and
  - at least one first insulating layer for isolating the upper electrode foil of the uppermost over-current protection module from the second metal terminal layer, the lower electrode foil of the lowest over-current protection module from the first metal terminal layer and adjacent over-current protection modules.
  - 7. The over-current protection device according to Claim 6, further comprising a solder mask disposed between the first metal terminal layer

15

20

25

and the second metal terminal layer.

- 8. The over-current protection device according to Claim 6, wherein the full-circular conductive through hole is disposed on the surface of the first metal terminal layer and the second metal terminal layer.
- 9. The over-current protection device according to Claim 7, wherein the full-circular conductive through hole is disposed on the surface of the solder mask and electrically connects first metal terimal layer and the second metal terminal layer by a metallic wire.
- 10. The over-current protection device according to Claim 6, further comprising a second insulating layer disposed between the upper over-current protection module and the lower over-current protection module, wherein the second insulating layer is made of epoxy resin and glass fiber composite.
- 11. The over-current protection device according to Claim 6, wherein the non-full-circular conductive through hole is a half-circular conductive through hole.